



# VNT008D/9D, VNS008D/9D

N-Channel Enhancement Mode Transistors

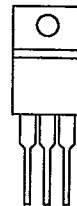
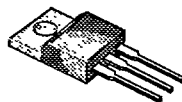
T-39-13

## PRODUCT SUMMARY

PART NUMBER	$V_{(BR)DSS}$ (V)	$r_{DS(ON)}$ ( $\Omega$ )	$I_D$ (A)
VNT008D	650	1.5	5.77
VNS008D	600	1.5	5.77
VNT009D	650	2.0	5.0
VNS009D	600	2.0	5.0

TO-220AB

TOP VIEW



- 1 GATE
- 2 DRAIN (Connected to TAB)
- 3 SOURCE

1 2 3

## ABSOLUTE MAXIMUM RATINGS ( $T_C = 25^\circ\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS	SYMBOL	VNT 008D	VNS 008D	VNT 009D	VNS 009D	UNITS
Drain-Source Voltage	$V_{DS}$	650	600	650	600	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	$\pm 20$	$\pm 20$	$\pm 20$	
Continuous Drain Current	$T_C = 25^\circ\text{C}$	$I_D$	5.77	5.77	5.0	A
	$T_C = 100^\circ\text{C}$		3.65	3.65	3.16	
Pulsed Drain Current <sup>1</sup>	$I_{DM}$	15	15	14	14	
Avalanche Current (See Figure 9)	$I_A$	5.77	5.77	5.0	5.0	
Power Dissipation	$T_C = 25^\circ\text{C}$	$P_D$	125	125	125	W
	$T_C = 100^\circ\text{C}$		50	50	50	
Operating Junction & Storage Temperature Range	$T_J, T_{stg}$	-55 to 150				$^\circ\text{C}$
Lead Temperature ( $1/16$ " from case for 10 sec.)	$T_L$	300				

4

## THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{thJC}$		1.0	K/W
Junction-to-Ambient	$R_{thJA}$		80	
Case-to-Sink	$R_{thCS}$	1.0		

<sup>1</sup>Pulse width limited by maximum junction temperature (refer to transient thermal impedance data, Figure 11).

## VNT008D/9D, VNS008D/9D



ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ Unless Otherwise Noted)						T-39-13	
PARAMETER	SYMBOL	TEST CONDITIONS	TYP	LIMITS		UNIT	
				MIN	MAX		
<b>STATIC</b>							
Drain-Source Breakdown Voltage	VNT008D, VNT009D VNS008D, VNS009D	$V_{(BR)DSS}$	$V_{GS} = 0\text{ V}, I_D = 2000\ \mu\text{A}$		650 600		V
Gate Threshold Voltage		$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 1000\ \mu\text{A}$		2.0	4.0	
Gate-Body Leakage		$I_{GSS}$	$V_{DS} = 0\text{ V}, V_{GS} = \pm 20\text{ V}$			$\pm 100$	nA
Zero Gate Voltage Drain Current		$I_{DSS}$	$V_{DS} = V_{(BR)DSS}, V_{GS} = 0\text{ V}$			2000	$\mu\text{A}$
			$V_{DS} = 0.8 \times V_{(BR)DSS}, V_{GS} = 0\text{ V}, T_J = 125^\circ\text{C}$			2000	
On-State Drain Current <sup>1</sup>		$I_{D(on)}$	$V_{DS} = 10\text{ V}, V_{GS} = 10\text{ V}$		5.7		A
Drain-Source On-State Resistance <sup>1</sup>	VNT008D, VNS008D VNT009D, VNS009D	$r_{DS(on)}$	$V_{GS} = 10\text{ V}, I_D = 3\text{ A}$	1.2 1.7		1.5 2.0	$\Omega$
	VNT008D, VNS008D VNT009D, VNS009D		$V_{GS} = 10\text{ V}, I_D = 3\text{ A}, T_J = 125^\circ\text{C}$	2.4 3.4		3.75 6.0	
Forward Transconductance <sup>1</sup>		$g_{fs}$	$V_{DS} = 15\text{ V}, I_D = 3\text{ A}$	3.3	3.0		S
<b>DYNAMIC</b>							
Input Capacitance		$C_{iss}$	$V_{GS} = 0\text{ V}, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$		1200	1500	$\text{pF}$
Output Capacitance		$C_{oss}$			140	150	
Reverse Transfer Capacitance		$C_{rss}$			40	50	
Total Gate Charge <sup>2</sup>		$Q_g$	$V_{DS} = 0.5 \times V_{(BR)DSS}, V_{GS} = 10\text{ V}, I_D = 5.7\text{ A}$		53	65	$\text{nC}$
Gate-Source Charge <sup>2</sup>		$Q_{gs}$			12.9		
Gate-Drain Charge <sup>2</sup>		$Q_{gd}$			26		
Turn-On Delay Time <sup>2</sup>		$t_{d(on)}$	$V_{DD} = 325\text{ V}, R_L = 130\ \Omega$ $I_D \approx 2.5\text{ A}, V_{GEN} = 10\text{ V}, R_G = 4.7\ \Omega$		15	20	ns
Rise Time <sup>2</sup>		$t_r$			20	25	
Turn-Off Delay Time <sup>2</sup>		$t_{d(off)}$			80	85	
Fall Time <sup>2</sup>		$t_f$			45	50	
<b>SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (<math>T_C = 25^\circ\text{C}</math>)</b>							
Continuous Current	VNT008D, VNS008D VNT009D, VNS009D	$I_S$				5.77 5.0	A
Pulsed Current <sup>3</sup>	VNT008D, VNS008D VNT009D, VNS009D	$I_{SM}$				15 14	
Forward Voltage <sup>1</sup>	VNT008D, VNS008D VNT009D, VNS009D	$V_{SD}$	$I_F = I_S, V_{GS} = 0\text{ V}$			2.5 2.0	V
Reverse Recovery Time		$t_{rr}$	$I_F = I_S, dI_F/dt = 100\text{ A}/\mu\text{s}$	400			ns
Reverse Recovery Charge		$Q_{rr}$		2.5			$\mu\text{C}$

<sup>1</sup>Pulse test: Pulse Width  $\leq 300\ \mu\text{sec}$ , Duty Cycle  $\leq 2\%$ .

<sup>2</sup>Independent of operating temperature.

<sup>3</sup>Pulse width limited by maximum junction temperature (refer to transient thermal impedance data, Figure 11).



# VNT008D/9D, VNS008D/9D

TYPICAL CHARACTERISTICS (25°C Unless Otherwise Specified)

T-39-13

Figure 1. Output Characteristics

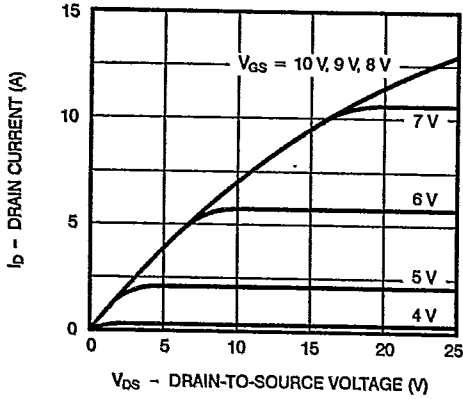


Figure 2. Transfer Characteristics

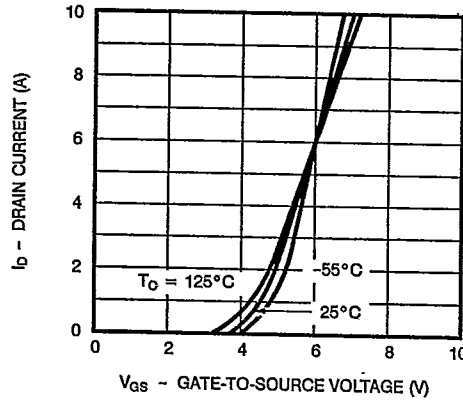


Figure 3. Transconductance

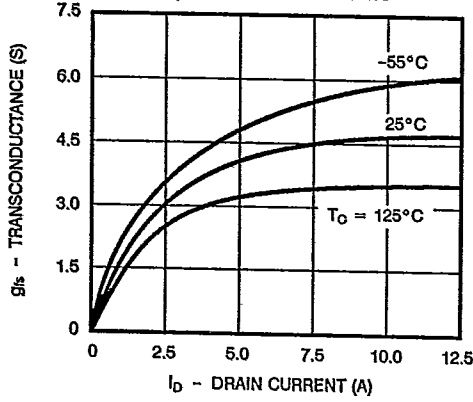
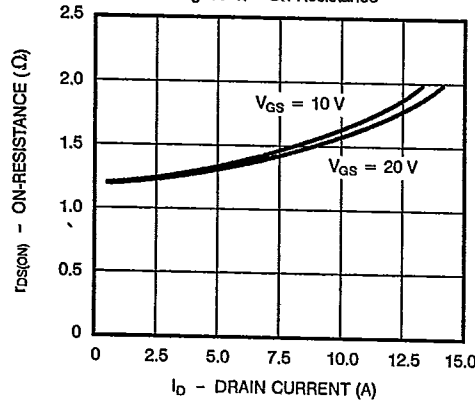


Figure 4. On-Resistance



4

Figure 5. Capacitance

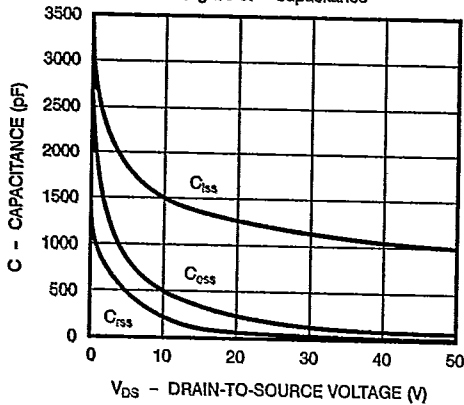
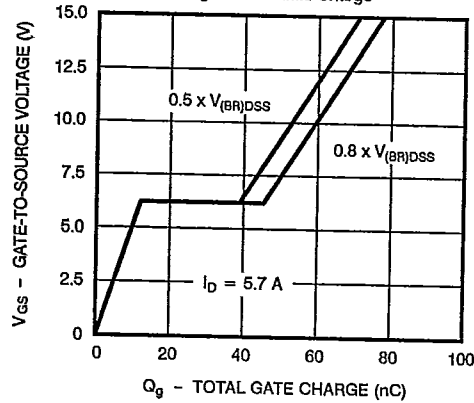


Figure 6. Gate Charge



# VNT008D/9D, VNS008D/9D



TYPICAL CHARACTERISTICS (Cont'd)

T-39-13

Figure 7. On-Resistance vs. Junction Temperature

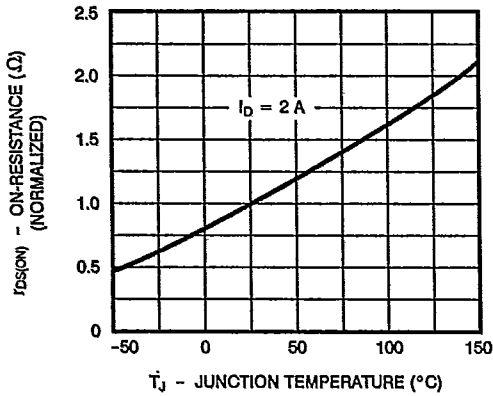
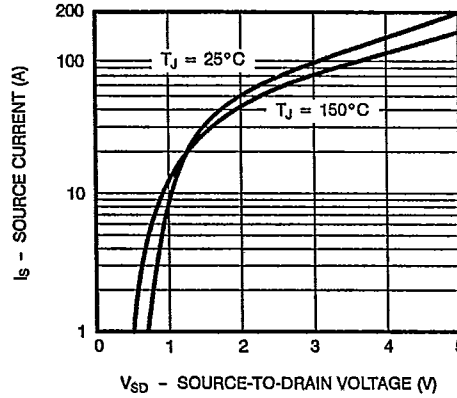


Figure 8. Source-Drain Diode Forward Voltage



THERMAL RATINGS

Figure 9. Maximum Avalanche and Drain Current vs. Case Temperature

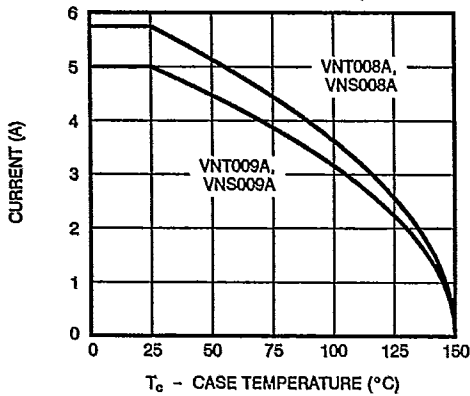


Figure 10. Safe Operating Area

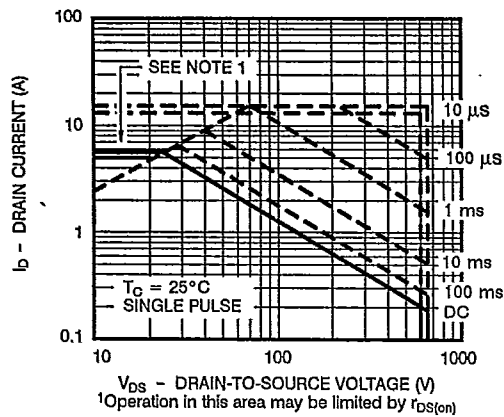


Figure 11. Normalized Effective Transient Thermal Impedance, Junction-to-Case

